

MOS FIELD EFFECT TRANSISTOR 2SK2140, 2SK2140-Z

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2140, 2SK2140-Z is N-channel Power MOS Field Effect Transistor designed for high voltage switching applications.

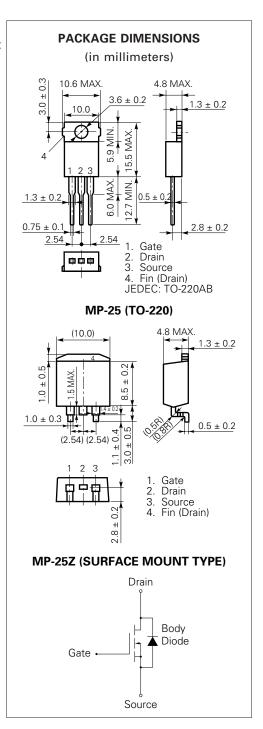
FEATURES

- Low On-state Resistance $R_{DS(on)} = 1.5 \ \Omega \ MAX. \ (V_{GS} = 10 \ V, \ I_{D} = 3.5 \ A)$
- Low Ciss Ciss = 930 pF TYP.
- · High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	V_{DSS}	600	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	ID(DC)	±7.0	Α
Drain Current (pulse)*	ID(pulse	±28	Α
Total Power Dissipation (Tc = 25 °C)	P _{T1}	75	W
Total Power Dissipation (T _A = 25 °C)	P _{T2}	1.5	W
Storage Temperature	T_{stg}	-55 to +150	°C
Channel Temperature	T_ch	150	°C
Single Avalanche Current**	las	7.0	Α
Single Avalanche Energy**	Eas	16.3	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



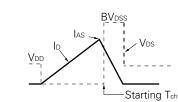


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

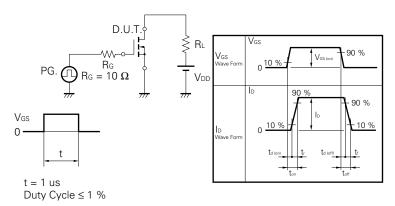
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	RDS(on)		1.1	1.5	Ω	Vgs = 10 V, ID = 3.5 A
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	l y _{fs} l	1.5			S	V _{DS} = 10 V, I _D = 3.5 A
Drain Leakage Current	IDSS			100	μΑ	V _{DS} = 600 V, V _{GS} = 0
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Input Capacitance	Ciss		930		pF	V _{DS} = 10 V
Output Capacitance	Coss		200		pF	V _G S = 0
Reverse Transfer Capacitance	Crss		40		pF	f = 1 MHz
Turn-On Delay Time	td(on)		20		ns	V _{GS} = 10 V
Rise Time	tr		12		ns	V _{DD} = 150 V
Turn-Off Delay Time	td(off)		60		ns	I_D = 3.5 A, R_G = 10 Ω
Fall Time	tf		12		ns	$R_L = 42.9 \Omega$
Total Gate Charge	QG		30		nC	V _G S = 10 V
Gate to Source Charge	Qgs		6.0		nC	ID = 7.0 V
Gate to Drain Charge	Q _{GD}		15		nC	V _{DD} = 450 V
Diode Forward Voltage	V _{F(S-D)}		1.0		V	IF = 7.0 A, VGS = 0
Reverse Recovery Time	trr		400		ns	IF = 7.0 A
Reverse Recovery Charge	Qrr		2.0		μC	$di/dt = 50 A/\mu s$

Test Circuit 1 Avalanche Capability

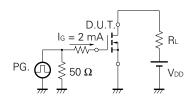
$\begin{array}{c} \text{D.U.T.} \\ \text{RG} = 25 \Omega \\ \text{VGS} = 20 \rightarrow 0 \end{array}$



Test Circuit 2 Switching Time

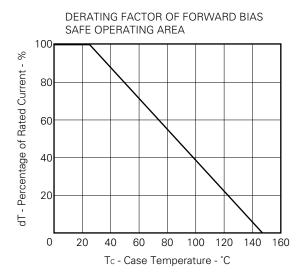


Test Circuit 3 Gate Charge

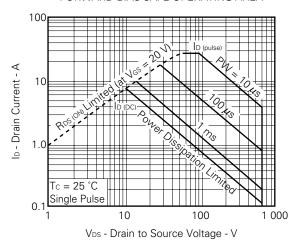


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

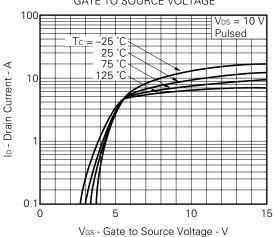
TYPICAL CHARACTERISTICS (TA = 25 °C)

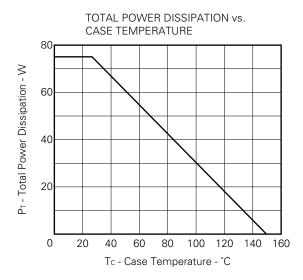


FORWARD BIAS SAFE OPERATING AREA

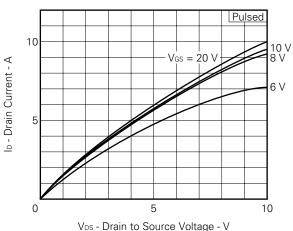


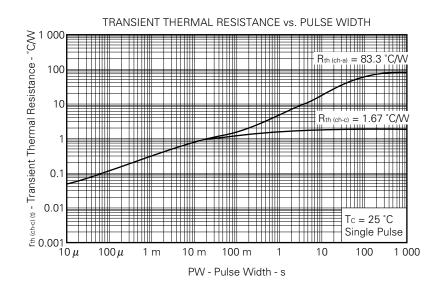
DRAIN CURRENT vs. GATE TO SOURCE VOLTAGE

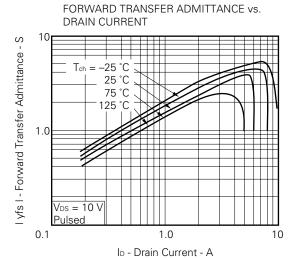


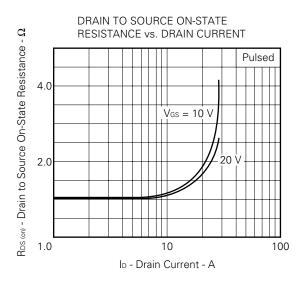


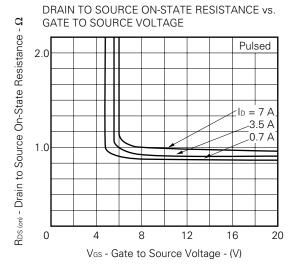
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

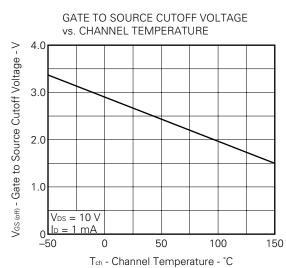


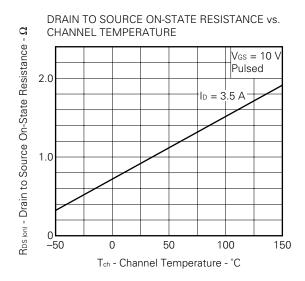


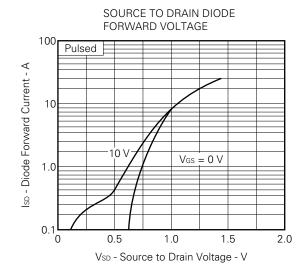


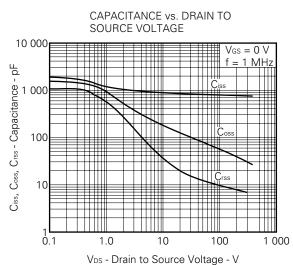


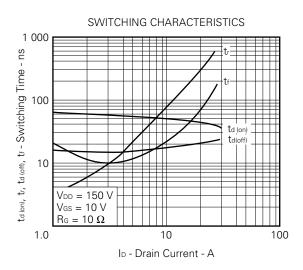


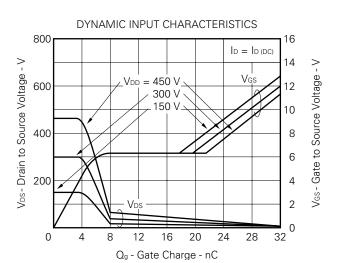


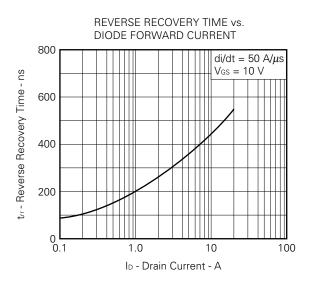


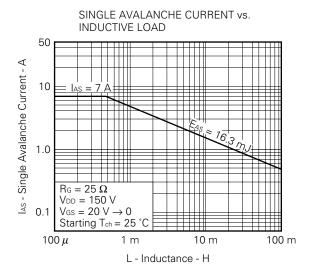




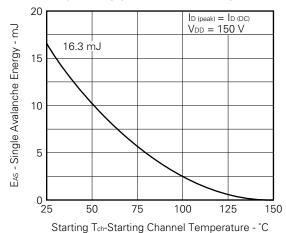








SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.